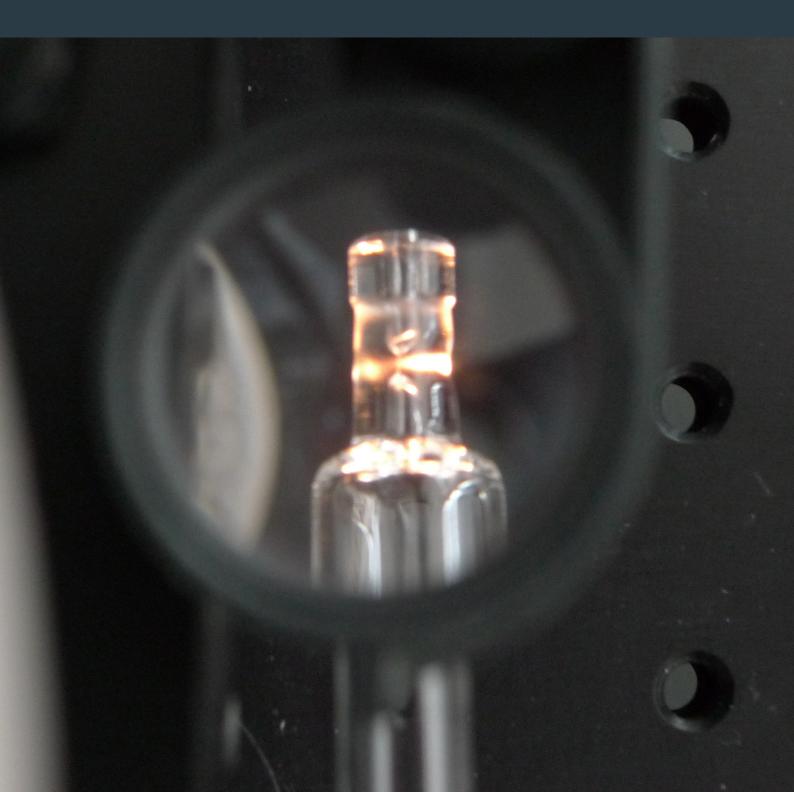
Medical Laser Innovative Laser Systems



INDUSTRIAL APPLICATIONS



LASER PARAMETERS

High power Mid-IR laser sources

	• •	
	Technology	Monolithic DPSSL
	Wavelength	2940 nm / 2020 nm
	Average Output Power (max)	up to 100 W
	Pulse Energy (max)	up to 8 J ^[1]
	Pulse Repetition Rate	up to 1 kHz
	Pulse Duration	up to 20 ms ^[1]
	Duty Cycle (max)	up to 10 %
	Mode of Operation	Pulsed
	Ideal Fiber Diameter	100 - 450 µm
	Beam Quality	M ² < 50
	Efficiency (optical-optical)	~ 10 %
	Divergence (half angle) (mrad)	< 50 mrad
	Beam Diameter	1.6 mm
	Beam Shape (focus)	top hat like

^[1] @ 2020 nm with Pantec Ultrapulse Mode (on request only)



3m.i.k.r.o.n.™ High-power, diode-pumped laser technology

3m.i.k.r.o.n.™ is the technology platform for compact, efficient, pumped solid-state technology, operating at wavelengths of fast and reliable lasers for a wide range of potential applica- 2 to 3 µm using different types of laser crystals (e.g. Er:YAG, tions in the field of medical engineering and industry. It enables a new generation of innovative mid-IR lasers based on diode-

Beam Quality

3m.i.k.r.o.n.™ offers high beam quality and accordingly high focusability.

Speed

3m.i.k.r.o.n.™ enables repetition rates up to 1 kHz.

Efficiency and TCO

Because of higher efficiency electricity consumption and cooling demands are reduced drastically compared to flash lamp pumped lasers. Higher efficiency and lack of consumables reduce the TCO drastically in comparison to CO2 lasers.

Life time and availability

Compared to flash lamps laser diodes are of longer life time. Compared to CO² lasers no consumables like laser gas are needed. Both effects involve longer maintenance intervals and thus higher availability.

Er:YLF, Tm:YAG).

Compactness

3m.i.k.r.o.n.™ modules are very compact due to their smaller pump sources and cooling systems, leading to laser devices, which are more convenient to use.

Flexibility

The wider range of adjustable laser parameters (pulse energy, pulse duration, repetition rate) offers a high level of flexibility for different applications.

Reliability

3m.i.k.r.o.n.™ modules are maintenance free and allow for robust construction of laser devices.

Process efficiency

The very good absorption of many organic materials at 3 µm wavelength allows for a very efficient cutting process. The 3 µm technology combines the benefits of CO² and solid state lasers.



All research experiments on the following pages were done with 3m.i.k.r.o.n.™ Er:YAG laser sources ranging from 20 to 30 W average output power.

ORGANIC MATTER CUTTING

Cutting, perforating, partly scoring

High flexibility: many different materials possible. Leather, wood, compounds ... High cutting quality and speed.



Cutting of Leather 1.3 mm thick Speed: 1.0 m / min



Cutting of organic compound 1.5 mm thick Speed: 1.2 m / min (wood/resin)



Cutting and perforation of wood 0.6 mm Speed: 7 m / min and 40 m / min

TEXTILE CUTTING

Cutting, perforating

High flexibility: many different materials possible. Alcantara, Cotton, Fleece ... High cutting quality and speed.



Cutting of Alcantara Speed: 8 m / min



Cutting of Jeans Speed: 7 m / min

PLASTIC CUTTING

Cutting, perforating and in special cases even welding High flexibility: many different materials possible. PP, PE, PEN, PET, antistatics, etc. High cutting quality and speed.

PAPER CUTTING

Cutting, perforating, scoring

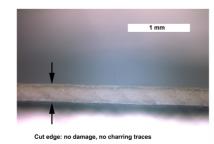
Outstanding cutting quality and speed. No burning and no soot stains.



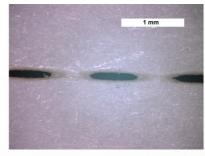
Cutting of printed paper (80 g / m²) Speed: 40 m / min

All experiments were done in cooperation with CHRISTOPH DEININGER, Ingenieurbüro für optische Technologien in Reutlingen, Germany

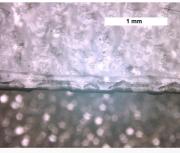
CHRISTOPH DEININGER



Cutting of plain paper (300 g / m²) Speed: 10 m / min



Long hole perforation of paper (80 g / m²) Speed: 75 m / min



Cutting of PE low density Speed: 8 m / min



Cutting of PP Speed: 10 m / min

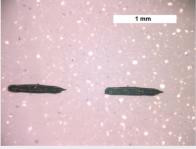






Cutting of Cotton Speed: 10 m / min





Long hole perforation of PEN Speed: 20 m / min

High Power 3 µm DPSSL Modules

High Power 2 µm DPSSL Modules

- . Compact monolithic laser systems
- . Highly efficient diode pumping
- . Fiber-coupled versions available
- . No high-voltage required
- . Reduced waste heat
- . Maintenance free
- . Process variability



Specifications

	DPM-2 (Er:YAG) free / fiber ^[1]	DPM-25 (Er:YAG) free / fiber [1]	DPM-50 (Er:YAG) free / fiber ⁽¹
Optical Parameters			
. Wavelength	2940 nm	2940 nm	2940 nm
• Average Output Power (max)	2 / 1.2 W	25 / 16 W	50 / 33 W
Pulse Energy (max)	20 ^[2] / 13 ^[2] mJ	300 ^[2] / 200 ^[2] mJ	600 ^[2] / 400 ^[2] mJ
 Pulse Repetition Rate 	up to 1 kHz	up to 1 kHz	up to 1 kHz
 Pulse Duration 	40 to 1000 ⁽³⁾ µs	40 to 1000 ⁽³⁾ µs	40 to 1000 ⁽³⁾ µs
 Average Current (max) 	30 A	25 A	25 A
 Mode of Operation 	Pulsed	Pulsed	Pulsed
 Efficiency (optical-optical) 	> 10 %	> 10 %	> 10 %
 Beam Shape (focus) 	top hat like	top hat like	top hat like
 Free Beam Quality 	M ² < 5	M ² < 25	M ² < 50
 Free Beam Diameter 	0.6 mm	1.6 mm	1.6 mm
 Free Divergence (half angle) 	< 25 mrad	< 25 mrad	< 50 mrad
 Fiber Diameter GeO2 ⁽¹⁾ 	~ 230 µm (NA < 0.2)	~ 230 µm (NA < 0.2)	~ 420 µm (NA < 0.2)
Cooling Requirements			
- Coolant	Distilled water with Algaecide	Distilled water with Algaecide	Distilled water with Algaecide
	and Corrosion Inhibitor	and Corrosion Inhibitor	and Corrosion Inhibitor
Coolant Temperature	20 to 35 °C	20 to 25 °C	20 to 25 °C
 Coolant Flow Rate 	≥ 1 lpm	> 5 lpm	≥ 6 lpm
Coolant Pressure	(1 - 3) bar	(2 - 5) bar	(3 - 5) bar
 Required Cooling Power 	~ 150 W @ 25 °C Environment	≥ 540 W @ 25 °C Environment	≥ 780 W @ 25 °C Environment
	Temperature	Temperature	Temperature
Electrical Parameters			
 Diode Forward Voltage 	2 V	~ 20 V	~ 30 V
 Diode Forward Current 	350 A Pulsed	300 A Pulsed	300 A Pulsed
 Average Power Consumption (max) 	< 120 W incl. 2 TECs	< 450 W	< 900 W
Mechanical Dimensions			
W x D x H	30 x 32 x 25 mm	120 x 96 x 75 mm	120 x 120 x 75 mm
• Weight	60 g	1.5 kg	1.7 kg
 Emission Height 	-	47.5 mm	47.5 mm

^[1] Fiber as specified by Pantec

⁽²⁾ For pulse durations > 600 µs

⁽³⁾ 600 µs standard, 1000 µs on request

. Compact monolithic laser systems

- . Highly efficient diode pumping
- . Fiber-coupled versions available
- . No high-voltage required
- . Reduced waste heat
- . Maintenance free
- . Process variability

Specifications

	DPM-25 (Tm:YAG) free / fiber [1]
Optical Parameters	
• Wavelength	2020 nm
 Average Output Power (max) 	25 / 20 W
• Pulse Energy (max)	250 / 200 mJ
 Pulse Repetition Rate (max) 	500 Hz
 Pulse Duration 	100 to 500 µs
 Average Current (max) 	8 A
 Mode of Operation 	Pulsed
 Efficiency (optical-optical) 	> 15 %
 Beam Shape (focus) 	top hat like
 Free Beam Quality 	M ² < 20
 Free Beam Diameter 	1.6 mm
 Free Divergence (half angle) 	< 20 mrad
Fiber Diameter Low-OH [1]	~ 100 µm (NA < 0.2)
Cooling Requirements	
- Coolant	Distilled water with Algaecide and
	Corrosion Inhibitor
Coolant Temperature	25 °C
Coolant Flow Rate	> 4 lpm
Coolant Pressure	(2 - 5) bar
 Required Cooling Power 	≥ 350 W @ 25 °C Environment
	Temperature
Electrical Parameters	
 Diode Forward Voltage 	< 40 V
 Diode Forward Current 	150 A
 Average Power Consumption (max) 	< 500 W
Mechanical Dimensions	
• W x D x H	120 x 96 x 75 mm
• Weight	1.5 kg
Emission Height	47.5 mm

^[1] Fiber as specified by Pantec

^[2] With Pantec Ultrapulse Mode (on request only)



2020 nm 50 / 40 W (0.5 - 4 ⁽²⁾) / (0.4 - 3.2 ⁽²⁾) J 500 Hz 100 to 500 (20 000 ⁽²⁾) µs 7 A Pulsed > 20 % top hat like M² < 30 1.6 mm < 30 mrad ~ 150 µm (NA < 0.2)

Distilled water with Algaecide and Corrosion Inhibitor 25 °C ≥ 5 lpm [3 - 5] bar ≥ 500 W @ 25 °C Environment Temperature

< 75 V 150 A < 750 W

120 x 96 x 75 mm 1.6 kg 47.5 mm

DPM-100 (Tm:YAG) free / fiber [1]

2020 nm 100 / 80 W (1 - 8 ^[2]) / (0.8 - 6.4 ^[2]) J 500 Hz 100 to 500 (20 000 ^[2]) μs 7 A Pulsed > 20 % top hat like M² < 40 1.6 mm < 40 mrad ~ 200 μm (NA < 0.2)

Distilled water with Algaecide and Corrosion Inhibitor 25 °C ≥ 6 lpm (3 - 5) bar ≥ 750 W @ 25 °C Environment Temperature

< 130 V 150 A < 1000 W

120 x 120 x 75 mm 1.7 kg 47.5 mm

Our services

- Laser development and system integration from prototyping to complete devices
- Customized laser sources
- Optical and mechnical design
- Contract development/manufacturing
- Medical device consulting (IP, Medical CE, ..)





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